



FFW

May 21, 2004

To: Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject: | Serial No. 10/811,371 03/26/04 |

Thomas Aisenbrey

LOW COST SHIELDED CABLE MANUFACTURED
FROM CONDUCTIVE LOADED RESIN-BASED
MATERIALS

INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation
In An Application.

The following Patents and/or Publications are submitted to
comply with the duty of disclosure under CFR 1.97-1.99 and
37 CFR 1.56.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service as first class
mail in an envelope addressed to: Commissioner for Patents,
P.O. Box 1450, Alexandria, VA 22313-1450, on May 24, 2004.

Stephen B. Ackerman, Reg.# 37761

Signature/Date

INT-03-009

UK Patent Application GB 2 377 449 A to Michael Patrick Sayers, "Electrically Conductive Polymer Composition," discusses electrically conductive compositions, and to their use to prevent electrostatic discharges and to earth electrical devices.

U.S. Patent Application INT-01-002_CIP, filed 12/04/02, Serial No. 10/309,429, assigned to the same assignee, "Low Cost Antennas Using Conductive Plastics or Conductive Composites," discusses antennas formed of conductive loaded resin-based materials comprising micron conductive powders or micron conductive fibers.

U.S. Patent Application INT-01-002, filed 02/14/02, Serial No. 10/075,778, assigned to the same assignee, "Low Cost Antennas Using Conductive Plastics or Conductive Composites," discusses antennas formed of conductive loaded resin-based materials comprising micron conductive powders or micron conductive fibers.

U.S. Patent 6,084,295 to Horiuchi et al., "Semiconductor Device and Circuit Board Used Therein," describes a semiconductor device mounted on a circuit board.

U.S. Patent Application Publication US 2002/0142653 A1 to Hosaka et al., "Binding Member for Coaxial Cable and an Electric Connector for Coaxial Cable Both Using Resin Solder, and a Method of Connecting the Binding Member to Coaxial Cable or the Electric Connector," discloses a binding member, or connector, to connect a coaxial cable to an electrical signal.

U.S. Patent Application Publication US 2003/0090345 A1 to Cooray et al., "Surface Conductive Resin, a Coaxial Cable, A Wiring Board, and Process for Manufacturing the Same," describes a method to form a coaxial cable.

U.S. Patent 6,265,667 to Stipes et al., "Coaxial Cable," describes a method to manufacture a coaxial cable.

U.S. Patent 5,946,798 to Buluschek, "Method for Manufacturing Coaxial Cables," discloses a method to manufacture a coaxial cable.

The following two U.S. Patents each describe a method to form a coaxial cable:

- 1) U.S. Patent 6,137,058 to Moe et al., "Coaxial Cable."
- 2) U.S. Patent 5,926,949 to Moe et al., "Method of Making Coaxial Cable."

Sincerely,

Stephen B. Ackerman, Reg. #37761

Form PTQ-1449 INFORMATION DISCLOSURE CITATION MAY 26 2004 (Use several sheets if necessary)				Docket Number (Optional) INT-03-009	Application Number 10/811,371	
				Applicant Thomas Aisenbrey		
				Filing Date 03/26/04	Group Art Unit	
U. S. PATENT DOCUMENTS						
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	PLACING DATE IF APPROPRIATE
	60842957/4/00	Horiuchi et al.	257	690		9/4/98
	62656677/24/01	Stipes et al.	174	102R		1/14/98
	59467989/7/99	Buluschek	29	828		3/14/97
	613705810/24/00	Moe et al.	174	102R		4/21/99
	59269497/27/99	Moe et al.	29	828		5/29/97
FOREIGN PATENT DOCUMENTS						
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
GB 2	377449A	1/15/03	UK Patent App	208K	3/08,7/06	
OTHER DOCUMENTS (Including Author, Title, Date, Page Numbers, Etc.)						
-	U.S. Patent App. INT-01-002-CIP, Ser.# 10/309,429, filed 12/04/02, assigned to the same assignee, "Low Cost Antennas Using Conductive Plastics or Conductive Composites".					
-	US Patent App. INT-01-002, Ser.# 10/075,778, filed 02/14/02 assigned to the same assignee, "Low Cost Antennas Using Conductive Plastics or Conductive Composites".					
EXAMINER	Plastics or Conductive Composites, DATE CONSIDERED					

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

Form PTO-1449	Docket Number (Optional) INT-03-009	Application Number 10 / 811,371
INFORMATION DISCLOSURE CITATION IN AN APPLICATION		
<i>(Use several sheets if necessary)</i>		

U. S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO

OTHER DOCUMENTS (*Including Author, Title, Date, Portion of Pages, Etc.*)

- U.S. Patent App. Pub. US 2002/0142653 A1 to Hosaka et al.,
Pub. Date 10/3/02, Filed 4/1/02, US Cl. 439/578.
- U.S. Patent App. Pub. US 2003/0090345 A1 to Cooray et al.
Pub. Date 5/15/03, Filed 9/27/02, US Cl. 333/239.

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.